

SIRP1608X09-H5

SMD Type 880nm Infrared Emitter

Features

- Small double-end package
- Viewing Angle = $\pm 37.5^{\circ}$
- High reliability
- Good spectral matching to Si photo detector
- RoHS compliance

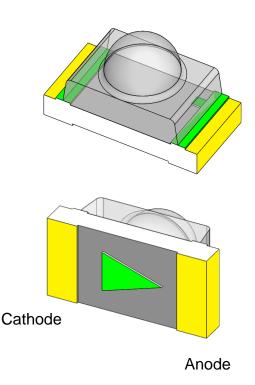
Applications

Infrared sensor

Description

The SIRP1608X09-H5 is a GaAlAs infrared LED housed in a miniature SMD package. The device has a peak wavelength of 880nm LED spectrally matched with phototransistor or photodiode.

Package Outline



Schematic





Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	70	mA	
IFP	Peak Forward Current	0.7	A	1
V _R	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	0C	
T _{stg}	Storage Temperature	-40 ~ +100	٥C	
T _{sol}	Soldering Temperature	260	0C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	140	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
le	Radiant Intensity	I _F =20mA	4.0	-	7.4	mW/sr	
		I _F =70mA	-	19	-		
λр	Peak Wavelength	I _F =20mA	870	880	890	nm	
Δλ	Spectral Bandwidth	I _F =20mA	-	30	-	nm	
θ1/2	Angle of Half Intensity	I _F =20mA	-	±37.5	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =20mA	1.20	1.35	1.7	- V	
		I _F =70mA	1.30	1.47	2.0		
I _R	Reverse Current	V _R =5V	-	-	10	μA	

Notes:

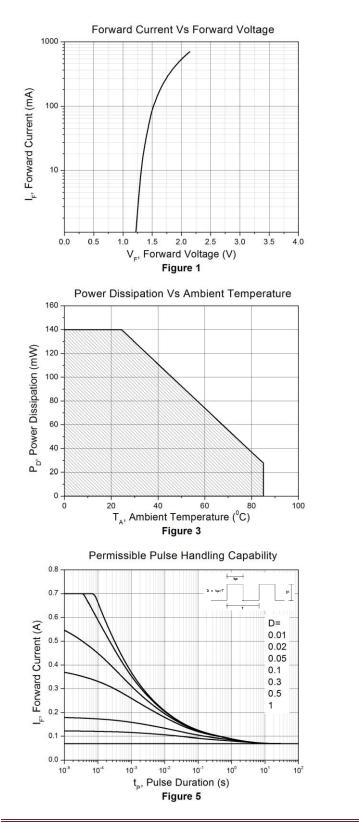
2. Soldering time \leq 5 seconds.

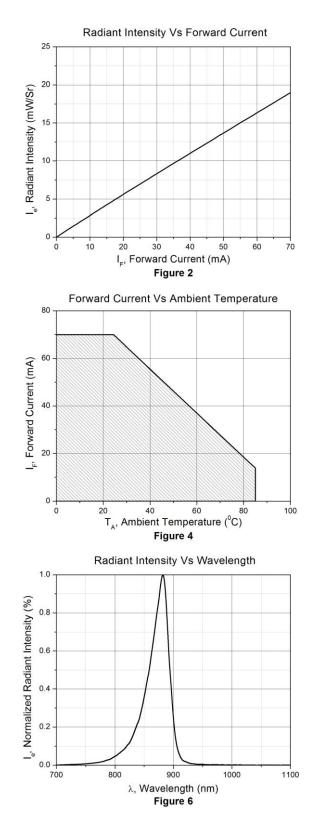
^{1.} IFP Conditions--Pulse Width $\leq 100 \mu s$ and Duty $\leq 1\%$.



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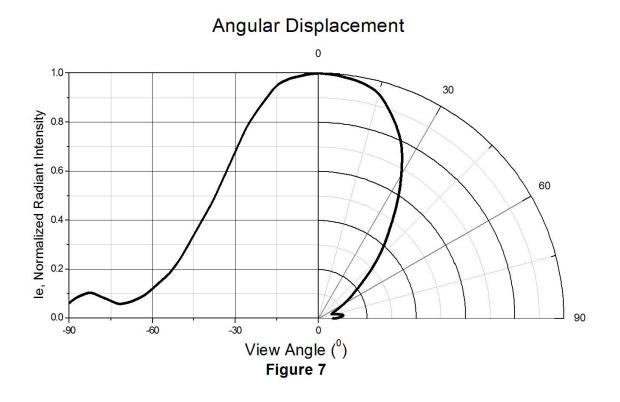
Typical Characteristic Curves





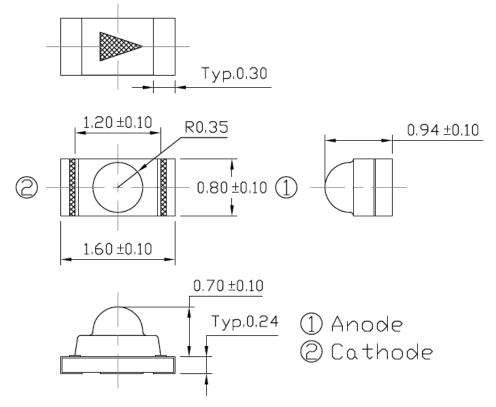


Typical Characteristic Curves

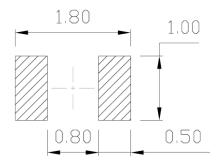








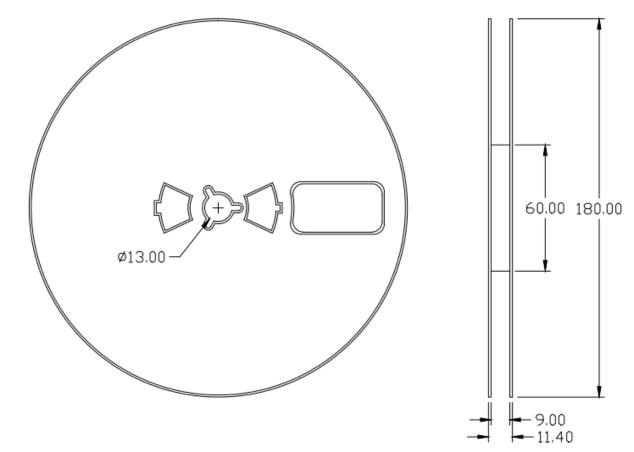
Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



Ordering Information

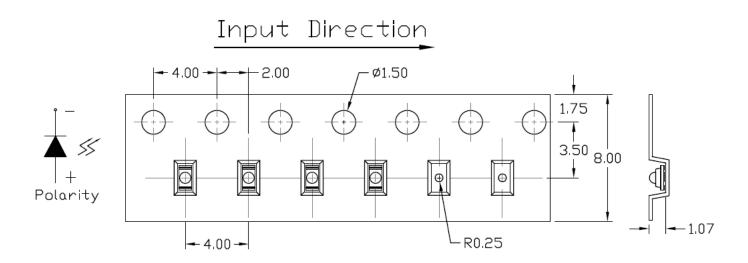
Part Number	Description	Quantity
SIRP1608X09-H5	Tape & Reel	4000 pcs





Reel Dimension All dimensions are in mm, unless otherwise stated

Tape Dimension All dimensions are in mm, unless otherwise stated





Label Form Specification



Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date Bin Code: Ie Ranks MADE IN CHINA: Production Place

Storage Condition

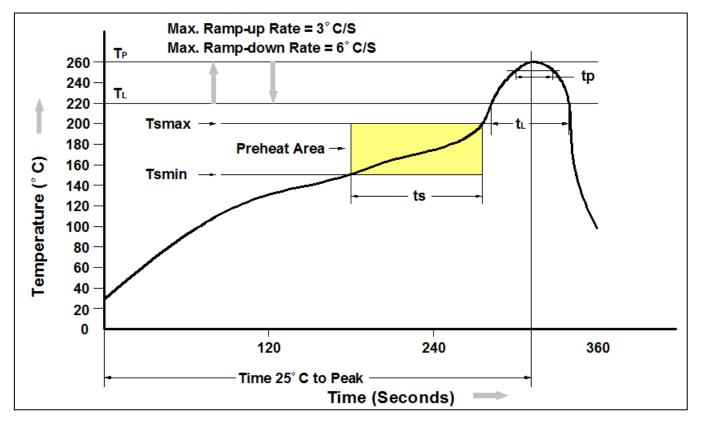
- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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